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| APPROVED BY: | DATE: | ELECTRONIC COMP GROUP SHARP COR | | REPRESENT | ATIVE DIVISION |
| J yoshikawa 5. | 2p. 10 19.7 | SPECIFICA | rion | OPTO-ELEC | TRONIC DEVICES DIV. |
| Please do not r 2. When using the in these specification for any damage | MODI mation sheets in reproduce or on is product, product | PHOTOCOUPLER EL No. PC357 Include materials protected und cause anyone to reproduce the lease observe the absolute maxes, as well as the precautions more of the product which deed in these specification sheets | m without Sharp imum ratings an entioned below. oes not comply w | PC357N61 PC357N71 PC357N91 PC357N91 PC357N01 PC357NT Charp Corporations of the instruction of the instructi | on ("Sharp"). In for use outlined no responsibility maximum ratings |
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1. Application

This specification applies to the outline and characteristics of photocoupler Model No. PC357.

2. Outline

Refer to the attached drawing No. CY9269K02.

3. Ratings and characteristics

Refer to the attached sheet, page 5 to 7.

4. Reliability

Refer to the attached sheet, page 8.

5. Incoming inspection

Refer to the attached sheet, page 9.

6. Supplement

- 6.1 Isolation voltage shall be measured in the following method.
- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The dielectric withstand tester with zero-cross circuit shall be used.
- (3) The wave form of applied voltage shall be a sine wave.

6.2 Packaging specifications

Refer to the attached sheet, page 10 to 12.

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6.3 Business dealing name ("\cap") mark indicates business dealing name of ordered product)

| Ordered product | Business dealing name | Rank mark | Ic (mA) | Test conditions |
|-----------------|--------------------------|-----------------------|------------|---------------------|
| | PC357N1T | A | 4.0 to 8.0 | |
| | PC357N2T | В | 6.5 to 13 | |
| | PC357N3T | С | 10 to 20 | I _F =5mA |
| | PC357N4T | D | 15 to 30 | |
| | PC357N5T | A or B | 4.0 to 13 | |
| | PC357N6T | B or C | 6.5 to 20 | V _{CE} =5V |
| | PC357N7T | C or D | 10 to 30 | |
| | PC357N8T | A, B or C | 4.0 to 20 | |
| | PC357N9T | B, C or D | 6.5 to 30 | Ta=25℃ |
| | PC357NOT | A, B, C or D | 4.0 to 30 | |
| 0 | PC357NT | A, B, C, D or no mark | 2.5 to 30 | |

6.4 The following selection shall be made as to the collector-emitter breakdown voltage (BVceo) in parameter 3.2. (Applied to lot No. "J5" [May 1997] or later)

| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|--|------------------------------|-------------------------------|------|------|------|------|
| Collector-emitter breakdown voltage | $\mathrm{BV}_{\mathrm{CEO}}$ | Ic=0.1mA I _F =0 | 70 | - | • | V |

6.5 This Model is approved by UL.

Approved Model No.: PC357

UL file No.: E64380

6.6 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

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6.7 ODS materials

This device \cdot component shall not contain the following materials. Also, the following materials shall not be used in the production process for this device \cdot component.

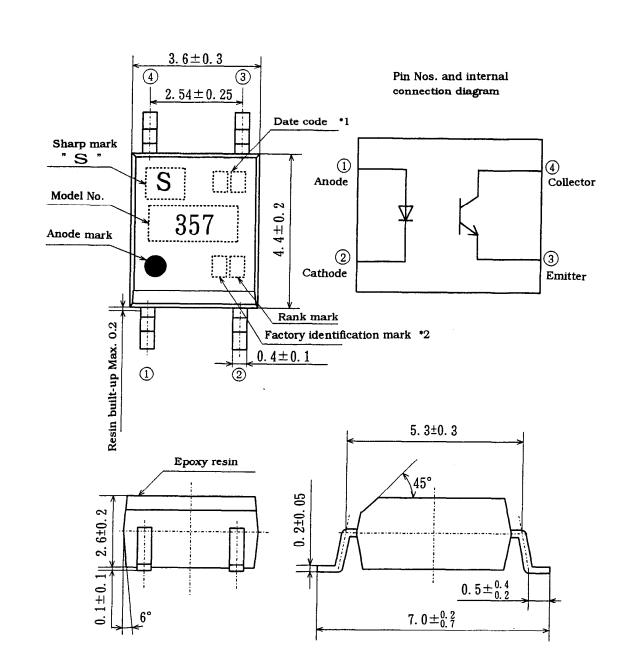
 $\begin{array}{c} \text{Materials for ODS} \ : \ \text{CFC}_{\text{S}}, \text{Halon, Carbon tetrachloride,} \\ 1.1.1\text{-Trichloroethane (Methylchloroform)} \end{array}$

6.8 Brominated flame retardants

Specific brominated flame retardants such as the ${\rm PBBO}_{\rm S}$ and ${\rm PBB}_{\rm S}$ are not used in this device component at all.

7. Notes

Refer to the attached sheet-1-1, 2.



- Product mass: Approx. 0.10g
- *1) 2-digit number shall be marked according to DIN standard.
- *2) Factory identification mark shall be or shall not be marked.
- *3) Marking is laser marking

| | UNIT: 1/1 mm |
|----------------|---|
| Name | PC357 Outline Dimensions (Business dealing name : PC357NT) |
| Drawing No. | CY9269K02 |

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3. Ratings and characteristics

3.1 Absolute maximum ratings

Ta=25℃

| | Parameter | Symbol | Rating | Unit |
|--------|--------------------------------|--------------------|-------------|-------|
| | *1 Forward current | $I_{\mathfrak{F}}$ | 50 | mA |
| Townst | *2 Peak forward current | $I_{ m FM}$ | 1 | A |
| Input | Reverse voltage | V_R | 6 | V |
| | *1 Power dissipation | Р | 70 | mW |
| | Collector-emitter voltage | V_{CEO} | 35 | V |
| Outnut | Emitter-collector voltage | V_{ECO} | 6 | V |
| Output | Collector current | I e | 50 | mA |
| | *1 Collector power dissipation | Pc | 150 | mW |
| | *1 Total power dissipation | Ptot | 170 | mW |
| | Operating temperature | Topr | -30 to +100 | Ĵ |
| | Storage temperature | Tstg | -40 to +125 | Ç |
| | *3 Isolation voltage | Viso | 3.75 | kVrms |
| | *4 Soldering temperature | Tsol | 260 | C |

^{*1} The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig. 1 to 4.

^{*2} Pulse width $\leq 100 \,\mu$ s, Duty ratio : 0.001 (Refer to Fig. 5)

^{*3} AC for 1 min, 40 to 60%RH, f=60Hz

^{*4} For 10 s

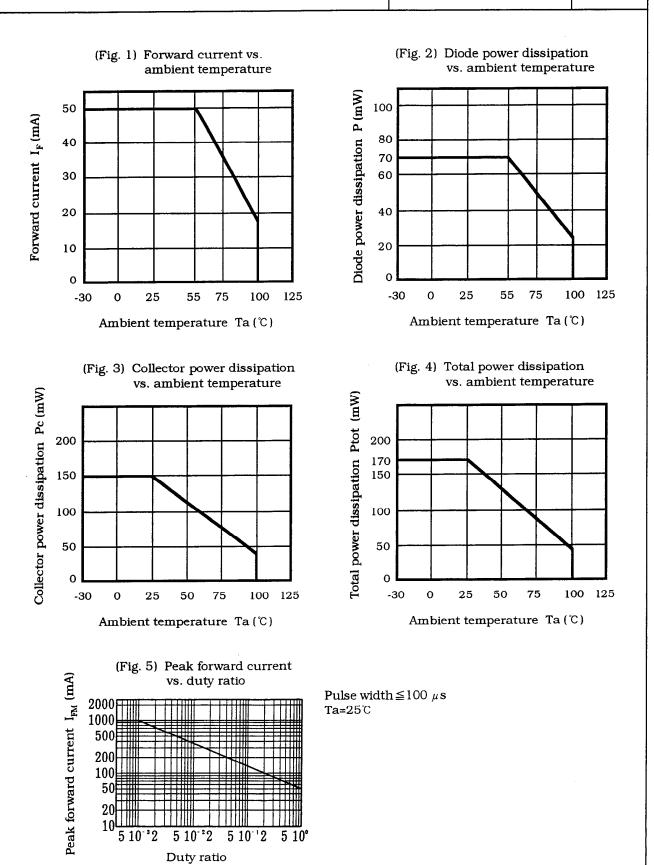
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3.2 Electro-optical characteristics

Ta=25℃

| | Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|------------------|--|----------------------|---|--------------------|------|------|------|
| | Forward voltage | $V_{\rm F}$ | I _F =20mA | - | 1.2 | 1.4 | V |
| Input | Reverse current | I _R | V _R =4V | - | - | 10 | μA |
| | Terminal capacitance | Ct | V=0, f=1kHz | - | 30 | 250 | pF |
| | Dark current | I_{CEO} | V _{CE} =20V, I _F =0 | - | - | 100 | nA |
| Output | Collector-emitter breakdown voltage | BV _{CEO} | Ic=0.1mA I _F =0 | 35 | - | - | V |
| | Emitter-collector breakdown voltage | BV _{ECO} | $I_{E}=10 \ \mu A, I_{F}=0$ | 6 | - | - | V |
| | Collector current | Ic | I_F =5mA, V_{CE} =5V | 2.5 | 5 | 30 | mA |
| | Collector-emitter saturation voltage | V _{CE(sat)} | I _F =20mA Ic=1mA | - | 0.1 | 0.2 | V |
| Transfer charac- | Isolation resistance | ` Riso | DC500V 40 to 60%RH | 5×10 ¹⁰ | 1011 | - | Ω |
| teristics | Floating capacitance | Cf | V=0, f=1MHz | - | 0.6 | 1.0 | pF |
| | Response time (Rise) | tr | V _{CE} =2V Ic=2mA | - | 4 | 18 | μs |
| | Response time (Fall) | tf | $R_L=100 \Omega$ | - | 3 | 18 | μS |

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Confidence level: 90%

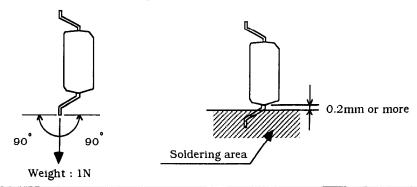
LTPD: 10%/20%

4. Reliability

The reliability of products shall satisfy items listed below.

| Test Items | Test Conditions | Failure Judgement Criteria | Samples (n) Defective(C) |
|---|--|---|--------------------------|
| Solderability *2 | 230℃,5 s | | n=11, C=0 |
| Soldering heat *3 | 260℃, 10 s | $V_F>U\times1.2$ | n=11, C=0 |
| Terminal strength (Bending) *4 | Weight : 1N 1 time/each terminal | $I_R>U\times 2$ | n=11, C=0 |
| Mechanical shock | 15000m/s^2 , 0.5ms 3 times/ $\pm X$, $\pm Y$, $\pm Z$ direction | I_{CEO} >U \times 2 I_{C} <l<math>\times0.7</l<math> | n=11, C=0 |
| Variable frequency vibration | 100 to 2000 to 100Hz/4min 200m/s ² 4 times/ X, Y, Z direction | $V_{\text{CE(sat)}} > U \times 1.2$ | n=11, C=0 |
| Temperature cycling | 1 cycle -40°C to +125°C (30min) (30min) 20 cycles test | U : Upper | n=22,C=0 |
| High temp. and high humidity storage | +85°C, 85%RH, 500h *5 | specification limit | n=22,C=0 |
| High temp. storage | +125℃, 1000h | L : Lower specification | n=22,C=0 |
| Low temp. storage | -40°C, 1000h | limit | n=22,C=0 |
| Operation life | I _F =50mA, Ptot=170mW Ta=25℃, 1000h | | n=22,C=0 |

- *1 Test method, conforms to JIS C 7021.
- *2 Solder shall adhere at the area of 95% or more of immersed portion of lead, and pin hole or other holes shall not be concentrated on one portion.
- $\mbox{*3}$ The lead pin depth dipped into solder shall be 0.2mm away from the root of lead pins.
- *4 Terminal bending direction is shown below.
- *5 It is evaluated after washing by specified solvent in attach sheet-1-1, 2.



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5. Incoming inspection

- 5.1 Inspection items
- (1) Electrical characteristics

$$\boldsymbol{V_F}, \boldsymbol{I_R}, \boldsymbol{I_{CEO}}, \boldsymbol{V_{CE(sat)}},$$
 Ic, Riso, Viso

(2) Appearance

5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied. The AQL according to the inspection items are shown below.

| Defect | Inspection item | AQL (%) | |
|-----------------|--|---------|--|
| Major defect | Electrical characteristics Unreadable marking | 0.1 | |
| Minor defect | Appearance defect except the above mentioned. | 0.4 | |

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6.2 Package specifications

6.2.1 Taping conditions

(1) Tape structure and Dimensions (Refer to the attached sheet, Page 10)

The tape shall have a structure in which a cover tape is sealed heat-pressed on the carrier tape of protect against static electricity.

(2) Reel structure and Dimensions (Refer to the attached sheet, Page 11)

The taping reel shall be of plastic with its dimensions as shown in the attached drawing.

(3) Direction of product insertion (Refer to the attached sheet, Page 11)

Product direction in carrier tape shall direct to the anode mark at the hole side on the tape.

(4) Joint of tape

The cover tape and carrier tape in one reel shall be jointless.

(5) The way to repair taped failure devices

The way to repair taped failure devices cut a bottom of carrier tape with a cutter, and after replacing to good devices, the cut portion shall be sealed with adhesive tape.

6.2.2 Adhesiveness of cover tape

• The exfoliation force between carrier tape and cover tape shall be 0.2N to 0.7N for the angle from 160° to 180° .

6.2.3 Rolling method and quantity

• Wind the tape back on the reel so that the cover tape will be outside the tape. Attach more than 20cm of blank tape to the trailer and the leader of the tape and fix the both ends with adhesive tape. One reel shall contain 750pcs.

6.2.4 Marking

- The outer packaging case shall be marked with following information.
- * Model No. * Number of pieces delivered * Production date

6.2.5 Storage condition

6.2.6 Safety protection during shipping

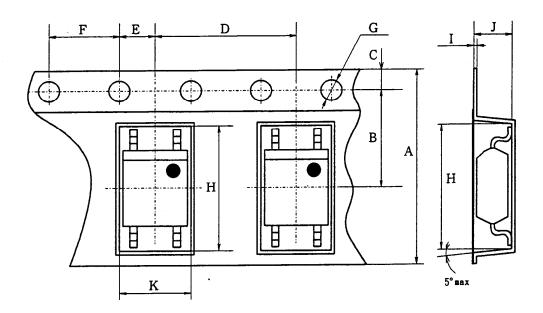
• There shall be no deformation of component or degradation of electrical characteristics due to shipping.

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Carrier tape structure and Dimensions



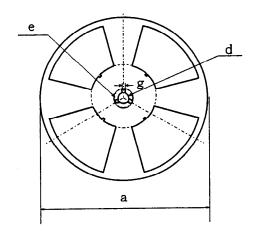
| Symbol Unit | A | В | С | D | E |
|----------------|------|--------------|--------------|-------------|--------------|
| mm | ±0.3 | ±0.05 5.5 | ±0.1 1.75 | ±0.1 8.0 | ±0.05 2.0 |

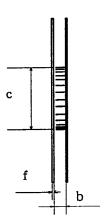
| Symbol Unit | F | G | Н | I | J | K |
|----------------|-------------|-----------------------|-------------|-------|-------------|---------------------|
| mm | ±0.1 4.0 | +0.1 -0.0 φ 1.5 | ±0.1 7.4 | ±0.05 | ±0.1 3.1 | ±0.1 4. 0 |

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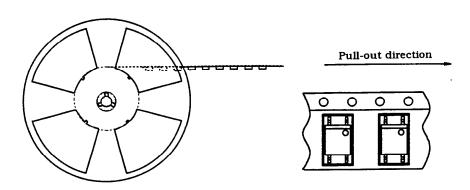
Reel structure and Dimensions





| S | ymbol | | Check word | | | | | |
|------|-------|-----|------------|--------|--------|--------|---------|---------|
| Unit | | а | b | С | d | е | f | g |
| | mm | 180 | 13.5±1.5 | 80±1.0 | 13±0.5 | 21±1.0 | 2.0±0.5 | 2.0±0.5 |

Direction of product insertion



Precautions for Photocouplers

1 For cleaning

(1) Solvent cleaning: Solvent temperature 45℃ or less

Immersion for 3 min or less

(2) Ultrasonic cleaning: The eaffect to device by ultrasonic cleaning- differs

by cleaning bath size, ultrasonic power

output, cleaning time, PWB size or device mounting condition etc. Please test it in actual using condition and confirm that doesn't occur any defect before starting

the ultrasonic cleaning.

Applicable solvent: Ethyl alcohol, Methyl alcohol, Freon TE · TF

Diflon-solvent S3-E, Trichloroethane

Please refrain from using Chloro Fluoro Carbon type solvent to clean devices as much as possible since it is internationally restricted to protect the ozonosphere. Before you use alternative solvent you are requested to confirm that it does not attack package resin. In case of using trichloroethane in this device by dry up $(100\,^{\circ}\text{C}, \text{ for } 30 \text{ to } 60\text{min})$ after washing.

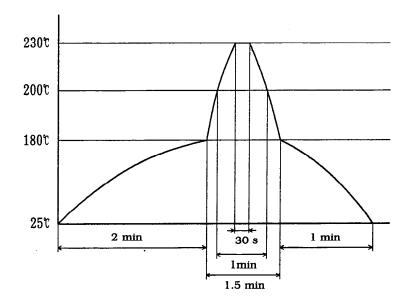
2. The LED used in the Photocoupler generally decreases the light emission power by operation. In case of long operation time, please design the circuit with considering the degradation of the light emission power of the LED. (50%/5years)

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3. Precautions for Soldering Photocouplers

(1) If solder reflow:

It is recommended that only one soldering be done at the temperature and the time within the temperature profile as shown in the figure below.



Since, influence to the device is different according to reflow equipment and its condition, please use the device after confirming no damage in the actual using condition.

(2) Other precautions

An infrared lamp used to heat up for soldering may cause a localized temperature rise in the resin. So keep the package temperature within that specified in Item (1). Also avoid immersing the resin part in the solder.